



MOSFETs Silicon 500V N-Channel MOS

■ Applications

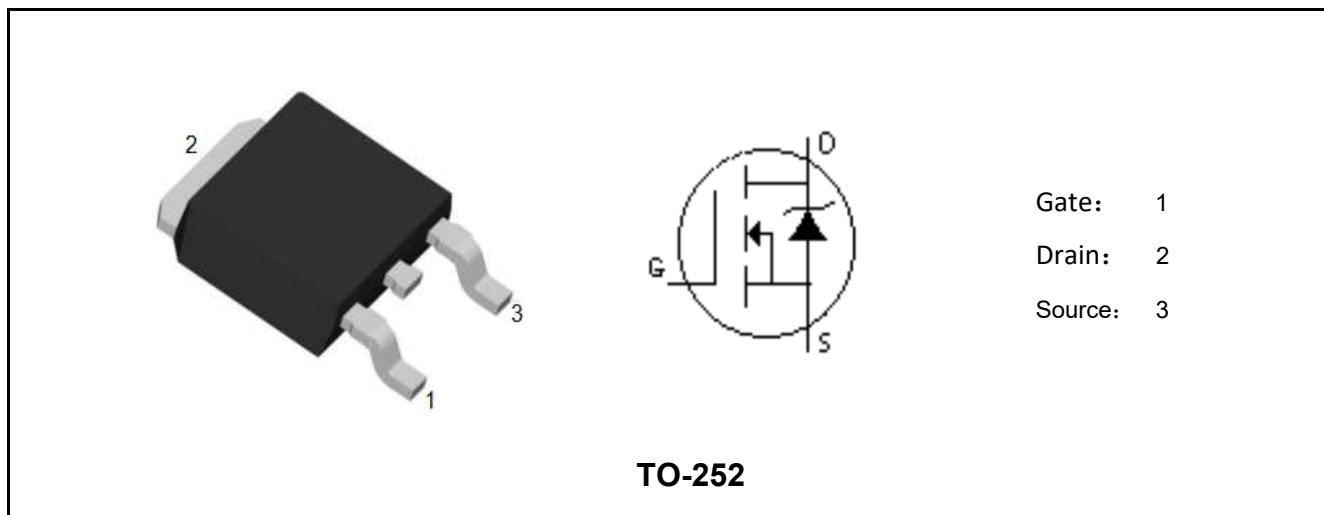
- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

■ Features

- Low $R_{DS(ON)}$
- Ultra Low Gate Charge
- RoHS Compliant
- 100% UIS and RG Tested

■ Product Summary

V_{DS}	500	V
I_D	5	A
$R_{DS(ON)} \text{ ,Typ@10V}$	1.3	Ω
Q_g	26	nC



Marking	Package	Packaging	Min. package quantity
MKIRF5N50S	TO-252	Tape & Reel	3000





■ Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	500	V
Gate-Source Voltage	V_{GS}	± 30	V
Continuous Drain Current (Note 1)	I_D	5	A
Drain Current-Pulsed (Note 1)	I_{DM}	20	A
Total Dissipation	P_D	76	W
Junction Temperature	T_j	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55-150	$^\circ\text{C}$
Single Pulse Avalanche Energy (Note 2)	E_{AS}	300	mJ

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

■ Thermal Characteristics

Parameter	Symbol	Max	Unit
Maximum Junction-to-Case	$R_{\theta JC}$	1.65	$^\circ\text{C}/\text{W}$
Maximum Junction-to-Ambient (Note 3)	$R_{\theta JA}$	60	$^\circ\text{C}/\text{W}$

Note 1: Ensure that the channel temperature does not exceed 150°C .

Note 2: $V_{DD}=50\text{V}$, $T_{ch}=25^\circ\text{C}$ (initial), $I_{AS}=5\text{A}$, $R_g=25\Omega$.

Note 3: The value of $R_{\theta JA}$ is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user's specific board design.

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.





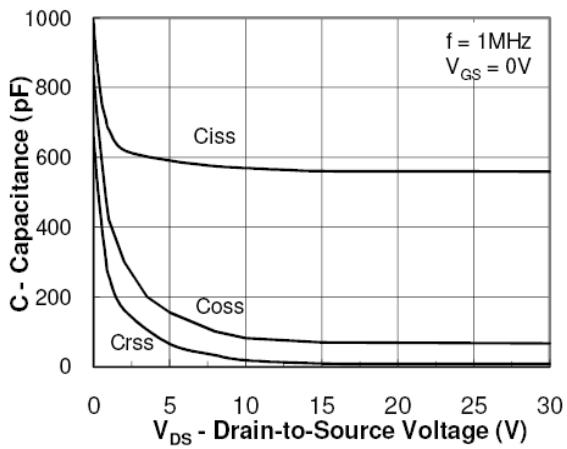
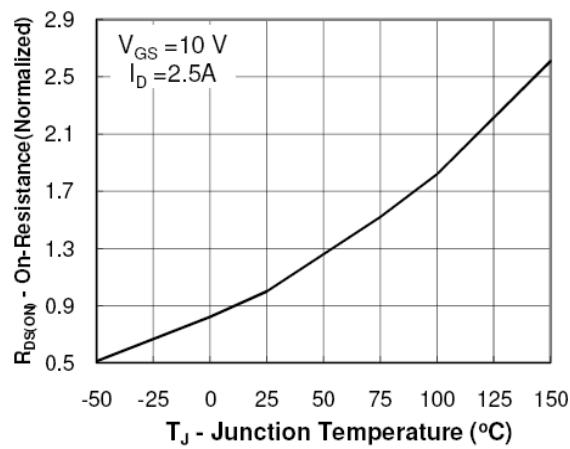
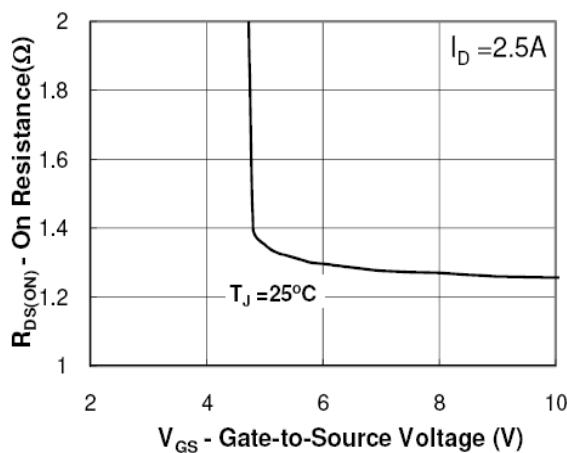
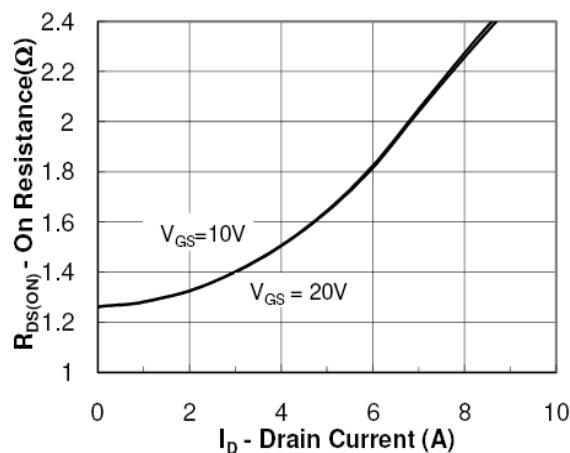
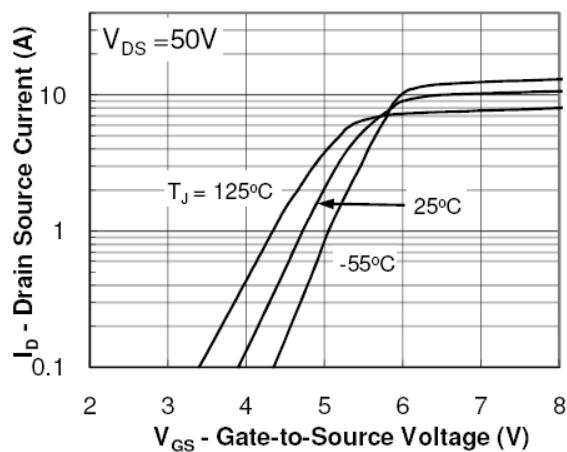
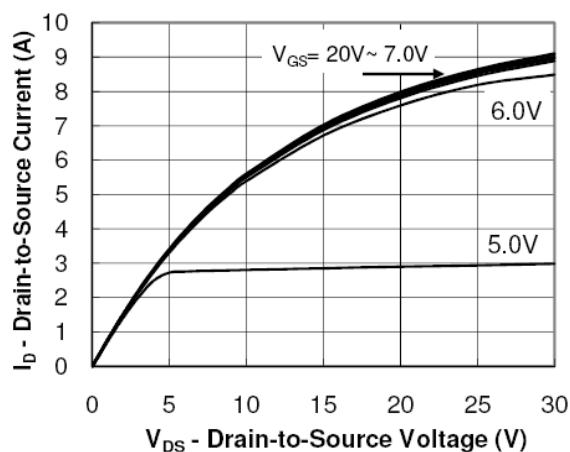
■ Electrical Characteristics (T_c=25°C unless otherwise noted)

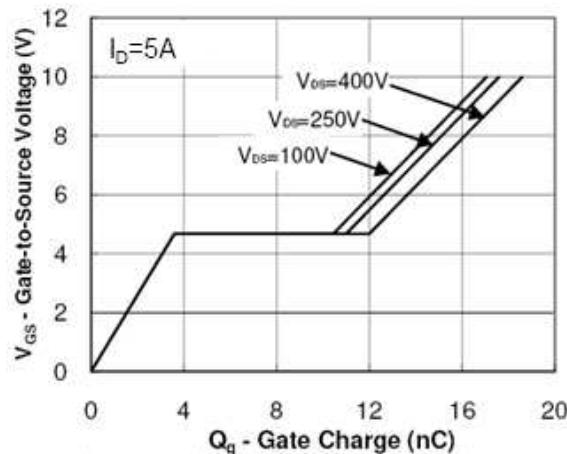
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Parameters						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	500	-	-	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =500V, V _{GS} =0V	-	-	1	uA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =250uA	2	3	4	V
Drain-Source On Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =2.5A	-	1.3	1.5	Ω
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1.0MHz	-	550	-	pF
Output Capacitance	C _{oss}		-	58	-	pF
Reverse Transfer Capacitance	C _{rss}		-	5	-	pF
Gate Resistance	R _g	V _{DS} =0V, V _{GS} =0V, f=1.0MHz	-	3	-	Ω
Switching Paramters						
Turn-On Delay Time	t _{d(on)}	V _{DS} =300V, I _D =5A, V _{GS} =10V, R _G =25Ω	-	18	-	ns
Turn-On Rise Time	t _r		-	25	-	ns
Turn-Off Delay Time	t _{d(off)}		-	23	-	ns
Turn-Off Rise Time	t _f		-	25	-	ns
Total Gate Charge	Q _g	V _{DS} =480V, I _D =5A, V _{GS} =10V	-	26	-	nC
Gate-Source Charge	Q _{gs}		-	4	-	nC
Gate-Drain Charge	Q _{gd}		-	15	-	nC
Source-Drain Characteristics						
Max. Diode Forward Cuurent	I _S	V _{GS} =0V, I _S =5A V _R =400V, I _F =5A, di/dt=100A/us	-	-	5	A
Max. Pulsed Forward Cuurent	I _{SM}		-	-	20	A
Diode Forward Voltage	V _{SD}		-	0.92	1.5	V
Reverse Recovery Time	t _{rr}		-	290	-	ns
Reverse Recovery Charge	Q _{rr}		-	1.5	-	μC



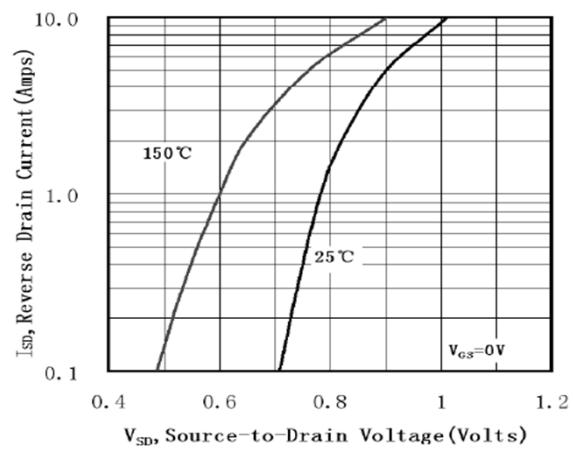


■ Characteristics Curves

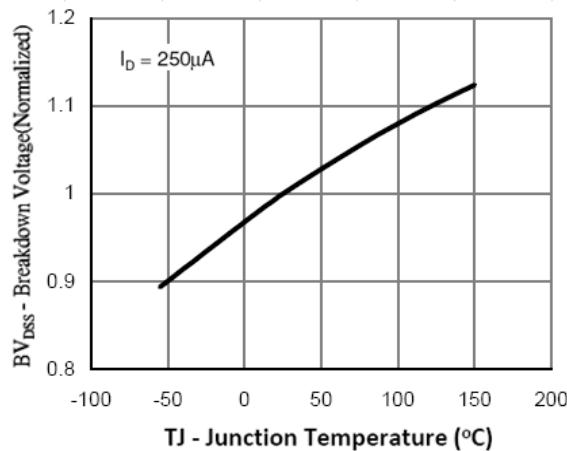




Gate Charge Waveform



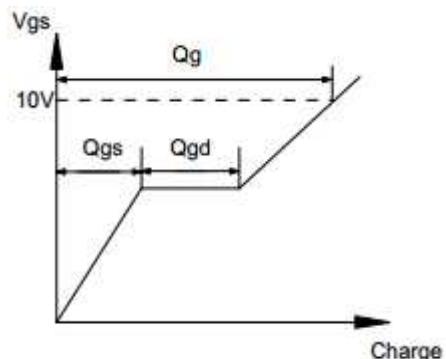
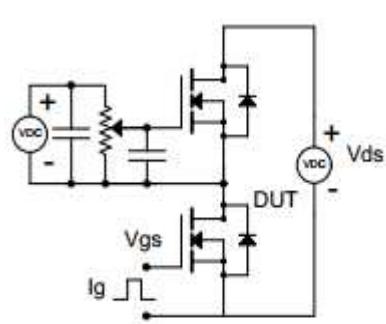
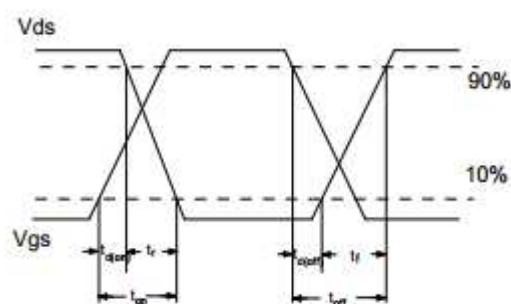
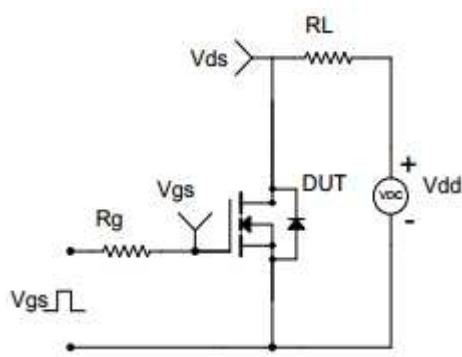
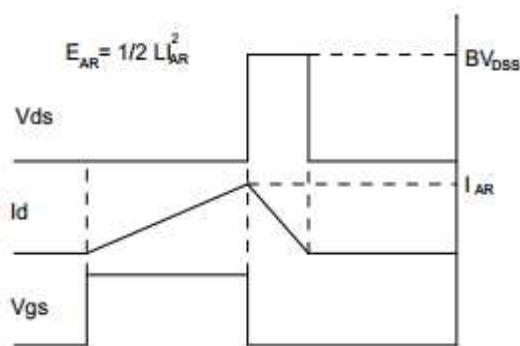
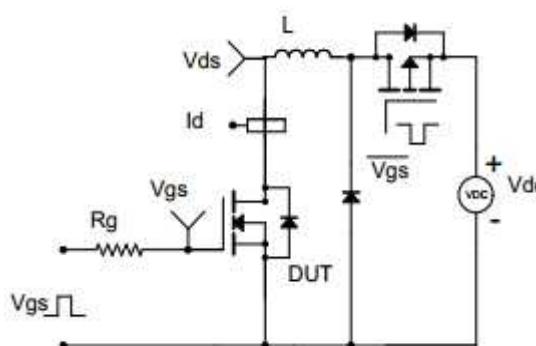
Source-Drain Diode Forward Voltage



Breakdown Voltage Vs Junction Temperature

Note : The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



**■ Test Circuit & Waveform****Gate Charge Test Circuit & Waveform****Resistive Switching Test Circuit & Waveform****Unclamped Inductive Switching (UIS) Test Circuit & Waveform**



■ TO-252 Package Dimensions

Unit: mm

Symbol	Min	Nom	Max	Symbol	Min	Nom	Max
A	2.10		2.50	E	5.80		6.30
B	0.80		1.25	e1	2.25	2.30	2.35
b	0.50		0.85	e2	4.45		4.75
b1	0.50		0.90	L1	9.50		10.20
b2	0.45		0.60	L2	0.90		1.45
C	0.45		0.60	L3	0.60		1.10
D	6.35		6.75	K	-0.1		0.10
D1	5.10		5.50				

